

Title: **Draft Reply to TISPAN on Workshop on iIMS over Fixed Accessi**

Work Item: -

Source: SA2 Chair (TSG SA)

To: ETSI TISPAN

Cc: CN, SA1, SA2, SA3, CN1, CN3, CN4

Contact Person:

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1. Discussion

3GPP TSG SA would like to thank ETSI TISPAN for the LS (SP-040869/05TD063) that proposes a second WS on iIMS over fixed accessi. 3GPP supports the proposed WS and the preferred dates of March 30-31, 2005.

3GPP would like to ensure that the invitation is open to participants from other SDOs and is not restricted to only TISPAN and 3GPP.

3GPP notes that even if CN1 and SA2 expert participation is requested, companies will send experts as they see appropriate.

3GPP also ask ETSI TISPAN to note that a workshop is not binding on the parent bodies; hence, agreement made at the WS may need endorsement in the parent bodies

2. Actions:

To SA2 group.

ACTION:

3GPP requests the 3GPP TSG SA WG2 management to organise such a workshop in conjunction with ETSI TISPAN and other SDOs.

To ETSI TISPAN group.

ACTION:

3GPP asks ETSI TISPAN endorse the workshop and to take note of the considerations above.

3. Dates of Next TSG-CN Meetings:

SA#27	14 th -17 th March, 2005	Tokyo, Japan
SA2#45	26 th January ñ 2 nd February, 2005	Budapest, Hungary
SA#28	6 th -9 th June, 2005	Quebec, Canada
SA2#46	4 th ñ 8 th April, 2005	Beijing, China